# Multistage MS Series MS2-010-06-06-11-11-00-W2
# MFG Part Number: 9320003-304

## Multistage MS Series Thermoelectric Cooler

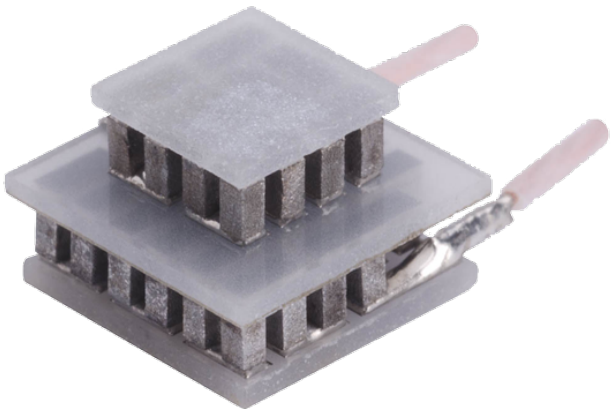
The MS2-010-06-06-11-11-00-W2 multistage thermoelectric cooler is able to reach colder temperatures than single stage thermoelectric coolers. It has a maximum Qc of 0.3 Watts when ΔT = 0 and a maximum ΔT of 94 °C at Qc = 0.

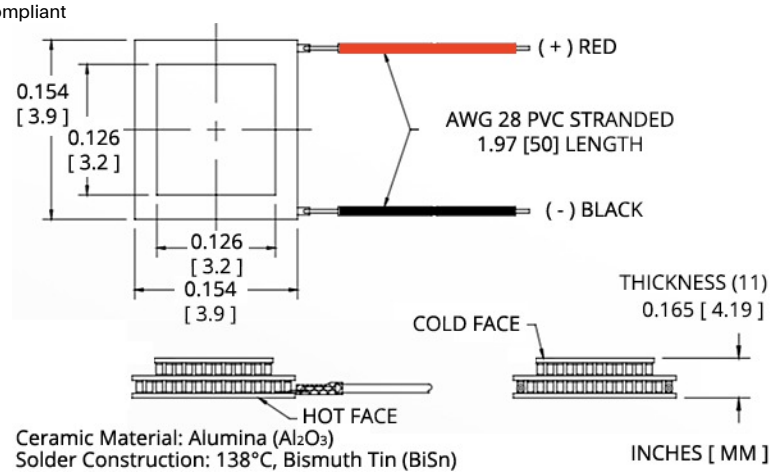
## Features

- High temperature differential
- Precise temperature control
- Reliable solid-state operation
- Environmentally-friendly
- DC operation
- RoHS-compliant

## Applications

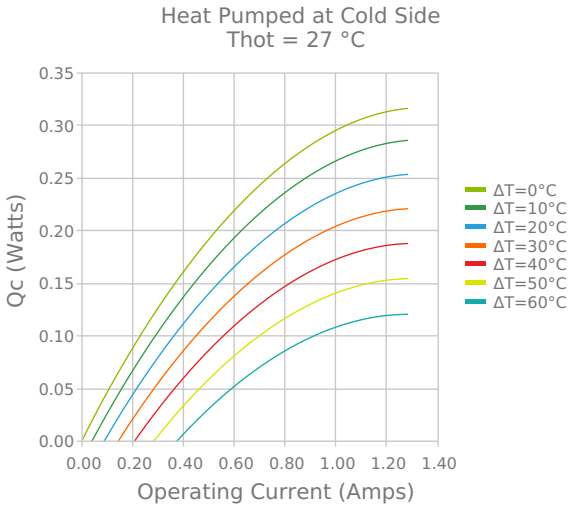
- Thermoelectric Cooling for CMOS Sensors

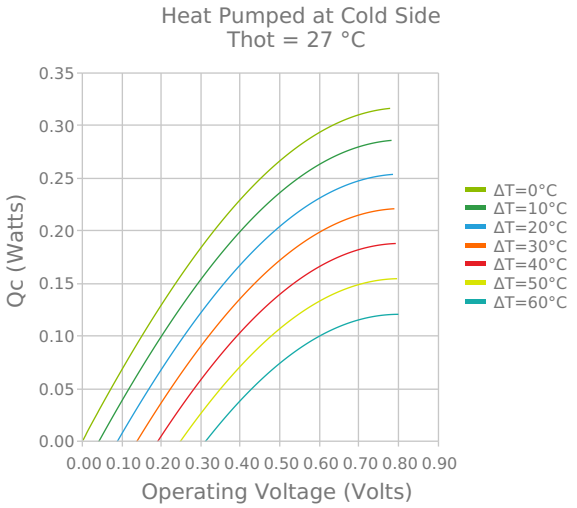


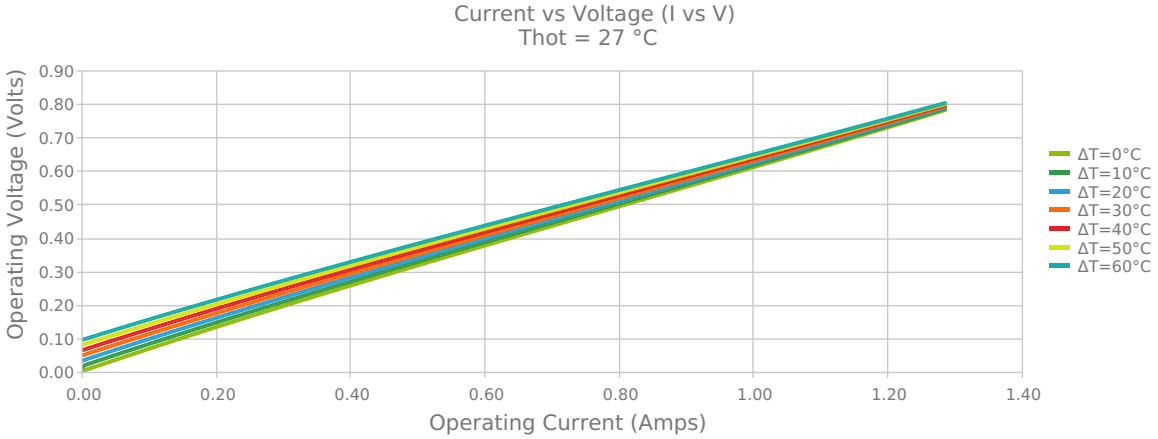



## Electrical and Thermal Performance

For maximum performance, be sure to orient the CONTROL side of the TEC against the application to be managed and the AMBIENT side against the heat sink or other heat rejection method. The CONTROL side is always opposite the side with lead attachments. Lead attachment is a passive heat loss and less impactful if located on the side that attaches to the heat exchanger.

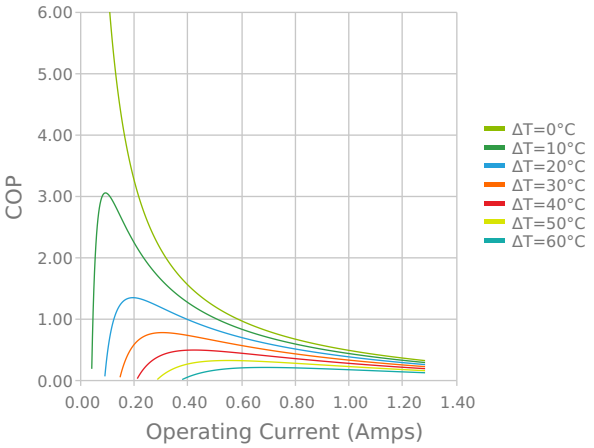


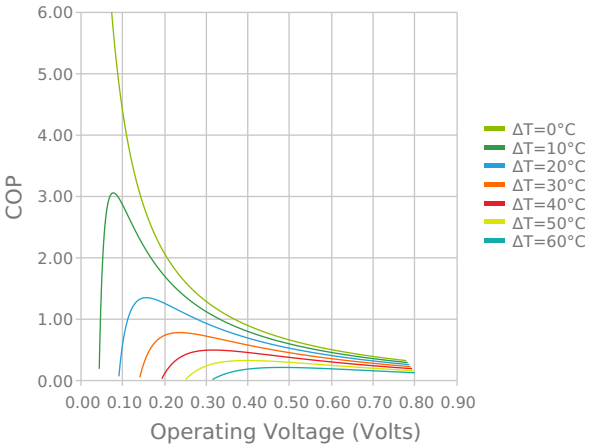



# Multistage MS Series MS2-010-06-06-11-11-00-W2
# MFG Part Number: 9320003-304

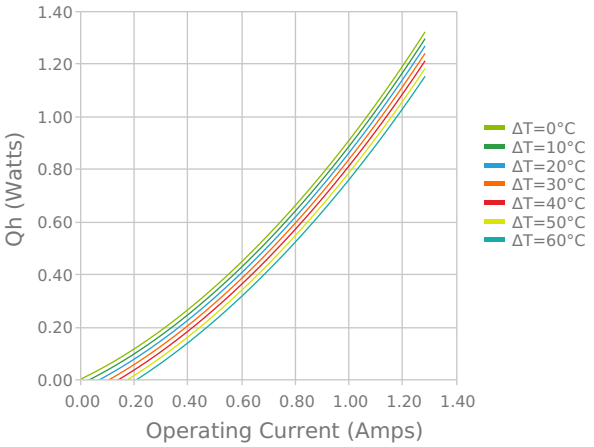
Coefficient of Performance (COP = Qc/Pin)
Thot = 27 °C



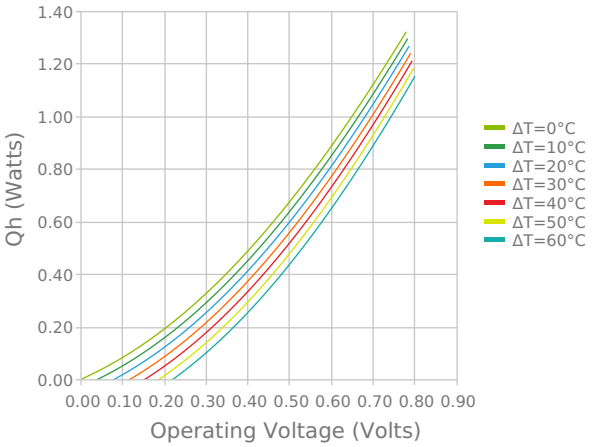

Coefficient of Performance (COP = Qc/Pin)
Thot = 27 °C



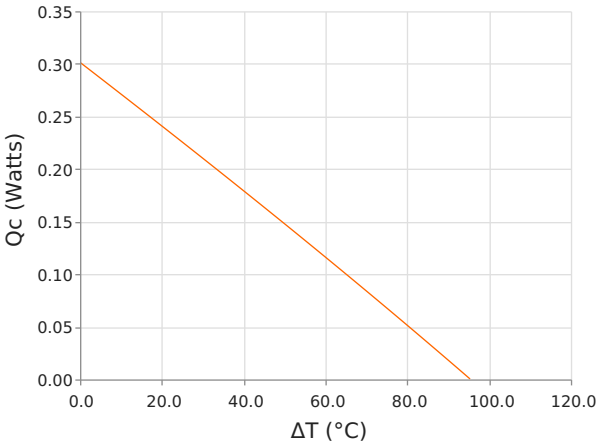

Total Heat Dissipated at Hot Side (Qh=Qc+Pin)
Thot = 27 °C



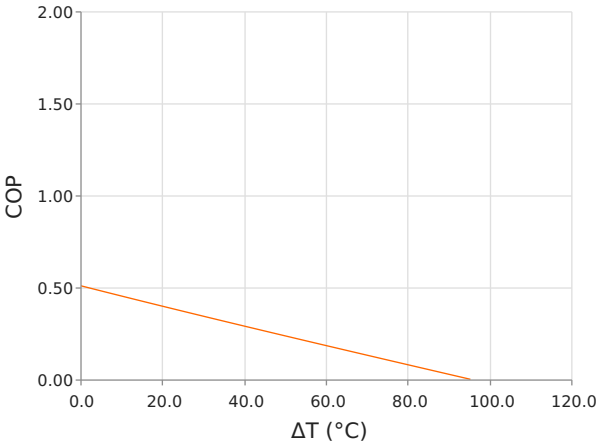

Total Heat Dissipated at Hot Side (Qh=Qc+Pin)
Thot = 27 °C




Heat Pumped at Cold Side (Qc)
Thot = 35 °C | Ioperating = 1 Amps




Coefficient of Performance (COP = Qc/Pin)
Thot = 35 °C | Ioperating = 1 Amps



# Multistage MS Series MS2-010-06-06-11-11-00-W2
# MFG Part Number: 9320003-304

## Specifications

| | |
|---|---|
| **Hot Side Temperature** | **27.0 °C** |
| **Qcmax (ΔT = 0)** | 0.3 Watts |
| **ΔTmax (Qc = 0)** | 94.0 °C |
| **Imax (I @ ΔTmax)** | 1.2 Amps |
| **Vmax (V @ ΔTmax)** | 0.8 Volts |
| **Module Resistance** | 0.63 Ohms |
| **Max Operating Temperature** | 80 °C |
| **Weight** | 1.0 gram(s) |

## Finishing Options

| Suffix | Thickness | Flatness / Parallelism | Hot Face | Cold Face | Lead Length |
|---|---|---|---|---|---|
| 00 | 4.403 ±0.203 mm<br>0.173 ± 0.008 in | 0.025 mm / 0.203 mm<br>0.001 in / 0.008 in | Metallized | Metallized | 50.0 mm<br>1.97 in |

## Sealing Options

| Suffix | Sealant | Color | Temp Range | Description |
|---|---|---|---|---|
| | None | | | No sealing specified |

## Notes

Max operating temperature: 80°C
Do not exceed Imax or Vmax when operating module
Reference assembly guidelines for recommended installation
Solder tinning also available on metallized ceramics



Revision: 00 Date: 06-01-2022

Print Date: 06-03-2025